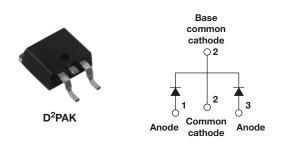
Vishay High Power Products

HEXFRED[®] Ultrafast Soft Recovery Diode, 2 x 4 A



PRODUCT SUMMARY				
V _R	600 V			
V _F at 4 A at 25 °C	1.8 V			
I _{F(AV)}	2 x 4 A			
t _{rr} (typical)	17 ns			
T _J (maximum)	150 °C			
Q _{rr}	40 nC			
dl _{(rec)M} /dt	280 A/µs			

FEATURES

- Ultrafast recovery
- Ultrasoft recovery
- Very low I_{RRM}
- Very low Q_{rr}
- Specified at operating conditions
- RoHS • Meets MSL level 1, per J-STD-020, LF maximum COMPLIANT peak of 260 °C HALOGEN FREE
- Halogen-free according to IEC 61249-2-21 definition
- Compliant to RoHS directive 2002/95/EC
- AEC-Q101 qualified

BENEFITS

- Reduced RFI and EMI
- Reduced power loss in diode and switching transistor
- Higher frequency operation
- Reduced snubbing
- Reduced parts count

DESCRIPTION

VS-HFA08TA60CSPbF is a state of the art center tap ultrafast recovery diode. Employing the latest in epitaxial construction and advanced processing techniques it features a superb combination of characteristics which result in performance which is unsurpassed by any rectifier previously available. With basic ratings of 600 V and 4 A per leg continuous current, the VS-HFA08TA60CSPbF is especially well suited for use as the companion diode for IGBTs and MOSFETs. In addition to ultrafast recovery time, the HEXFRED® product line features extremely low values of peak recovery current (I_{RRM}) and does not exhibit any tendency to "snap-off" during the t_b portion of recovery. The HEXFRED features combine to offer designers a rectifier with lower noise and significantly lower switching losses in both the diode and the switching transistor. These HEXFRED advantages can help to significantly reduce snubbing, component count and heatsink sizes. The HEXFRED VS-HFA08TA60CSPbF is ideally suited for applications in power supplies and power conversion systems (such as inverters), motor drives, and many other similar applications where high speed, high efficiency is needed.

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Cathode to anode voltage	V _R		600	V	
Maximum continuous forward current	I _F	T _C = 100 °C	4		
per device			8	А	
Single pulse forward current	I _{FSM}		25	A	
Maximum repetitive forward current	I _{FRM}		16		
Movimum nouver discipation	P _D	T _C = 25 °C	25	10/	
Maximum power dissipation		T _C = 100 °C	10	W	
Operating junction and storage temperature range	T _J , T _{Stg}		- 55 to + 150	°C	



VS-HFA08TA60CSPbF



Vishay High Power Products

HEXFRED[®] Ultrafast Soft Recovery Diode, 2 x 4 A

ELECTRICAL SPECIFICATIONS (T _J = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
Cathode to anode breakdown voltage	V _{BR}	I _R = 100 μA		600	-	-	
		I _F = 4.0 A		-	1.5	1.8	v
Maximum forward voltage V _{FM}	V _{FM}	I _F = 8.0 A	See fig. 1	-	1.8	2.2	
		I _F = 4.0 A, T _J = 125 °C		-	1.4	1.7	
Maximum reverse		$V_R = V_R$ rated	See fig. 2	-	0.17	3.0	
leakage current	I _{RM}	$T_J = 125 \text{ °C}, V_R = 0.8 \text{ x } V_R \text{ rated}$	See lig. 2	-	44	300	μA
Junction capacitance	CT	V _R = 200 V	See fig. 3	-	4.0	8.0	pF
Series inductance	L _S	Measured lead to lead 5 mm from package body - 8.0 - n		nH			

DYNAMIC RECOVERY CHARACTERISTICS ($T_J = 25$ °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
	t _{rr}	$I_F = 1.0 \text{ A}, \text{ d}I_F/\text{d}t = 200 \text{ A}/\mu\text{s}, \text{ V}_R = 30 \text{ V}$		-	17	-	
Reverse recovery time See fig. 5, 6 and 16	t _{rr1}	T _J = 25 °C		-	28	42	ns
	t _{rr2}	T _J = 125 °C	I _F = 4.0 A dI _F /dt = 200 A/μs V _R = 200 V	-	38	57	
Peak recovery current	I _{RRM1}	T _J = 25 °C		-	2.9	5.2	Α
See fig. 7 and 8	I _{RRM2}	T _J = 125 °C		-	3.7	6.7	~
Reverse recovery charge	Q _{rr1}	T _J = 25 °C		-	40	60	nC
See fig. 9 and 10	Q _{rr2}	T _J = 125 °C		-	70	105	no
Peak rate of fall of recovery current during t _b See fig. 11 and 12	dl _{(rec)M} /dt1	T _J = 25 °C		-	280	-	A/µs
	dl _{(rec)M} /dt2	T _J = 125 °C		-	235	-	-7 μ5

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Lead temperature	T _{lead}	0.063" from case (1.6 mm) for 10 s	-	-	300	°C
Thermal resistance, junction to case	R _{thJC}		-	-	5.0	K/W
Thermal resistance, junction to ambient	R _{thJA}	Typical socket mount	-	-	80	- r./ vv
M/sight			-	2.0	-	g
Weight			-	0.07	-	oz.
Mounting torque			6.0 (5.0)	-	12 (10)	kgf · cm (lbf · in)
Marking device		Case style D ² PAK		HFA08	TA60CS	



100

10

1

0.1

94596_01

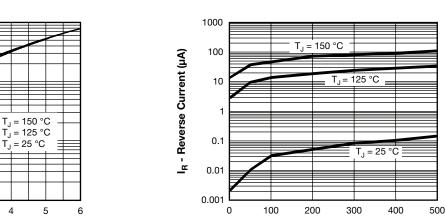
0

I_F - Instantaneous Forward Current (A)



Vishay High Power Products

Ultrafast Soft Recovery Diode, 2 x 4 A



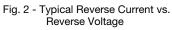
94596_02

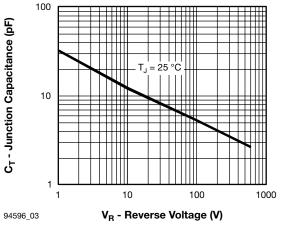


3

2

V_R - Reverse Voltage (V)







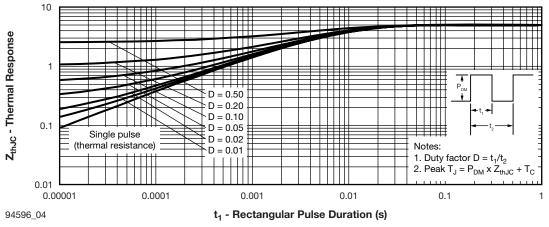


Fig. 4 - Maximum Thermal Impedance ZthJC Characteristics

VS-HFA08TA60CSPbF

Vishay High Power Products

HEXFRED[®] Ultrafast Soft Recovery Diode, 2 x 4 A

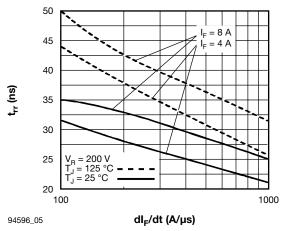


Fig. 5 - Typical Reverse Recovery Time vs. dl_F/dt

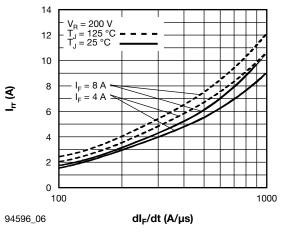
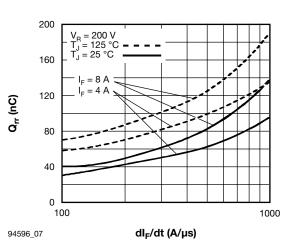
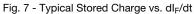


Fig. 6 - Typical Recovery Current vs. dl_F/dt



SHA'



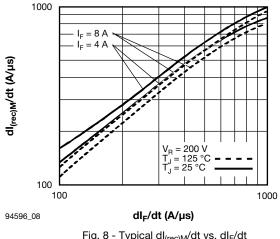


Fig. 8 - Typical $dI_{(rec)M}/dt$ vs. dI_F/dt



Vishay High Power Products

HEXFRED[®] Ultrafast Soft Recovery Diode, 2 x 4 A

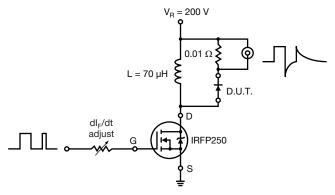


Fig. 9 - Reverse Recovery Parameter Test Circuit

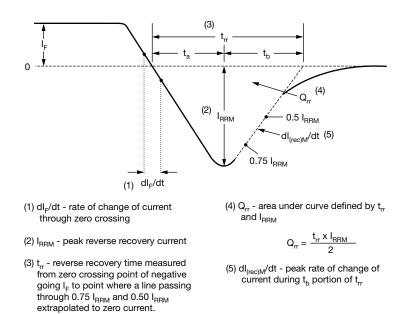


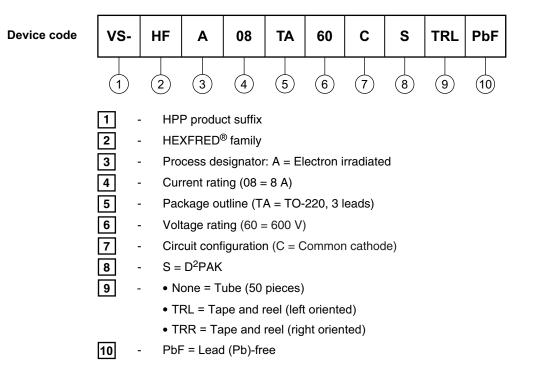
Fig. 10 - Reverse Recovery Waveform and Definitions

VS-HFA08TA60CSPbF



Vishay High Power Products HEXFRED[®] Ultrafast Soft Recovery Diode, 2 x 4 A

ORDERING INFORMATION TABLE



LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?95046			
Part marking information	www.vishay.com/doc?95054			
Packaging information	www.vishay.com/doc?95032			



Vishay

Disclaimer

All product specifications and data are subject to change without notice.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained herein or in any other disclosure relating to any product.

Vishay disclaims any and all liability arising out of the use or application of any product described herein or of any information provided herein to the maximum extent permitted by law. The product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein, which apply to these products.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications unless otherwise expressly indicated. Customers using or selling Vishay products not expressly indicated for use in such applications do so entirely at their own risk and agree to fully indemnify Vishay for any damages arising or resulting from such use or sale. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

Product names and markings noted herein may be trademarks of their respective owners.